1200V, 75A, Trench FS II Fast IGBT

General Description:

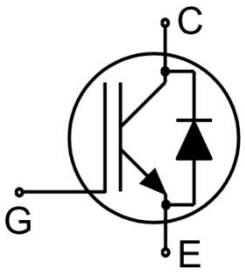
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 1200V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology Offering
- Very low $V_{CE(sat)}$
- High speed switching
- Positive temperature coefficient in $V_{CE(sat)}$
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Welding



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE75TD120WT	TO-247	NCE75TD120WT

TO-247

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate- Emitter Voltage	±30	V
I_C	Collector Current	150	A
	Collector Current @T_C = 100 °C	75	A
I_{Cpuls}	Pulsed Collector Current，t_p limited by T_{jmax}	225	A
-	turn off safe operating area，V_{CE}=1200V，Tj=150°C	225	A
I_F	Diode Continuous Forward Current @T_C = 100 °C	75	A
I_{FM}	Diode Maximum Forward Current	225	A
P_D	Power Dissipation @ T_C = 25°C	833	W
	Power Dissipation @T_C = 100 °C	417	W
T_J,T_{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
T_L	Maximum Temperature for Soldering	260	°C

Thermal Characteristic

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction to case for IGBT	0.18	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to case for Diode	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

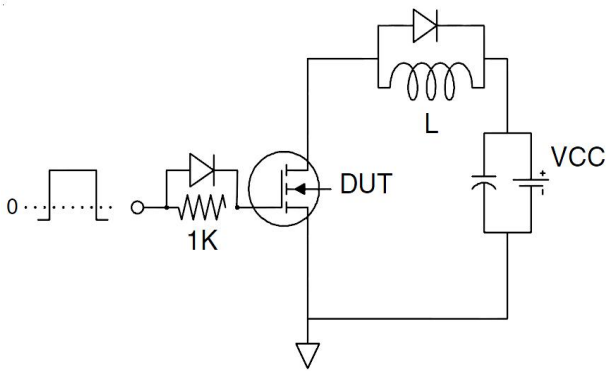
Symbol	Parameter	Test Conditions		Value			Units
				Min.	Typ.	Max.	
Static Characteristics							
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	V_{GE}=0V,I_{CE}=1mA		1200	--	--	V
I_{CES}	Collector-Emitter Leakage Current	V_{GE} =0V,V_{CE}=1200V		--	--	5	uA
$I_{GES(F)}$	Gate to Emitter Forward Leakage	V_{GE}=+30V,V_{CE}=0V		--	--	200	nA
$I_{GES(R)}$	Gate to Source Reverse Leakage	V_{GE}=-30V,V_{CE} =0V		--	--	200	nA
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C=75A	Tj=25°C	--	1.9	2.2	V
		V_{GE}=15V	Tj=150°C	--	2.2	--	V
$V_{GE(th)}$	Gate Threshold Voltage	I_C=1mA,V_{CE}=V_{GE}		4.5	--	6.5	V
Dynamic Characteristics							
C_{ies}	Input Capacitance	V_{CE}=30V,V_{GE}=0V, f=1MHz		--	13830	--	pF
C_{oes}	Output Capacitance			--	320	--	
C_{res}	Reverse Transfer Capacitance			--	280	--	
Q_g	Total Gate Charge	V_{CC}=960V, I_C=75A, V_{GE}=15V		--	450	--	nC
Q_{ge}	Gate to Emitter Charge			--	87	--	
Q_{gc}	Gate to Collector Charge			--	204	--	
Switching Characteristics							
$t_{d(ON)}$	Turn-on Delay Time	V_{CE}=600V,I_C=75A, V_{GE}=0/15V, R_g=8Ω Inductive Load		--	19	--	ns
t_r	Rise Time			--	17	--	
$t_{d(OFF)}$	Turn-Off Delay Time			--	170	--	
t_f	Fall Time			--	18	--	
E_{on}	Turn-On Switching Loss			--	5.5	--	mJ
E_{off}	Turn-Off Switching Loss			--	2.5	--	
E_{ts}	Total Switching Loss			--	8.0	--	

Electrical Characteristics of the Diode(T_C= 25°C unless otherwise specified)：

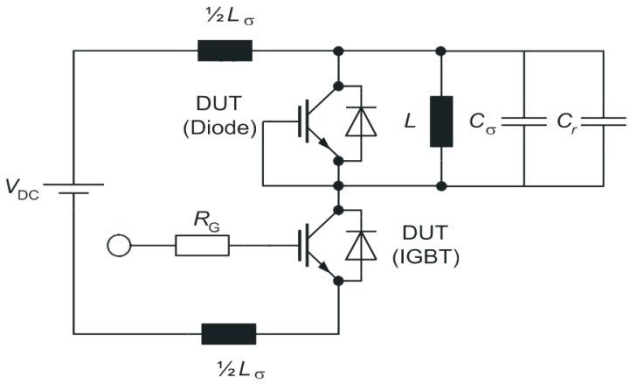
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{FM}	Diode Forward Voltage	I_F=37.5A	--	2.2	3.0	V
T_{rr}	Reverse Recovery Time	I_F=37.5A, di/dt=700A/us	--	150	--	ns
I_{RRM}	Diode Peak Reverse Recovery Current		--	10	--	A
Q_{rr}	Reverse Recovery Charge		--	2.2	--	uC
Pulse width t_{tp}≤380μs,δ≤2%						

Test Circuit

1) Gate Charge Test Circuit

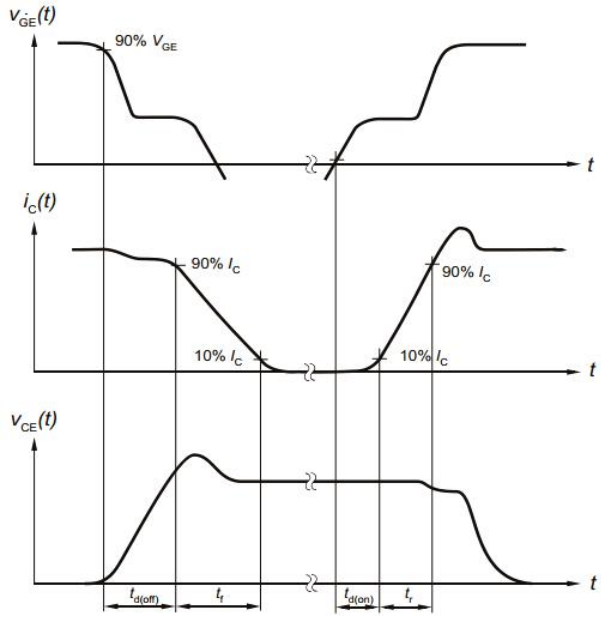


2) Switch Time Test Circuit

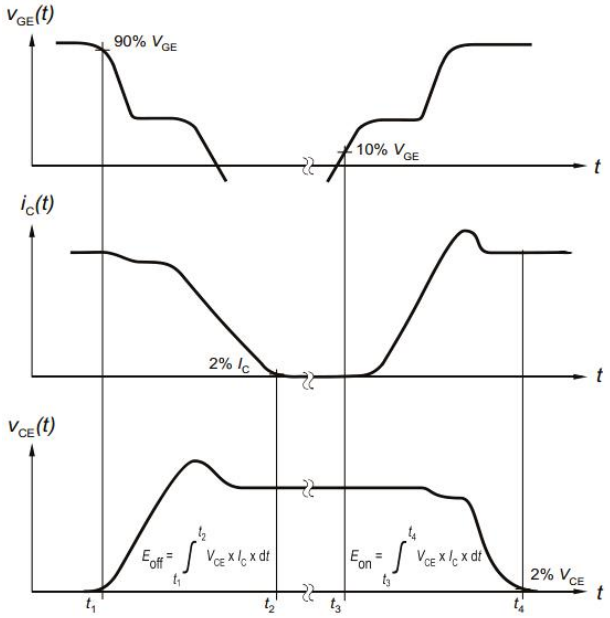


Switching characteristics

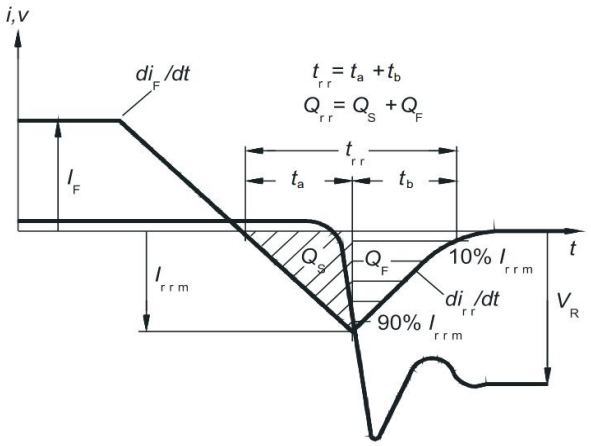
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics



Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

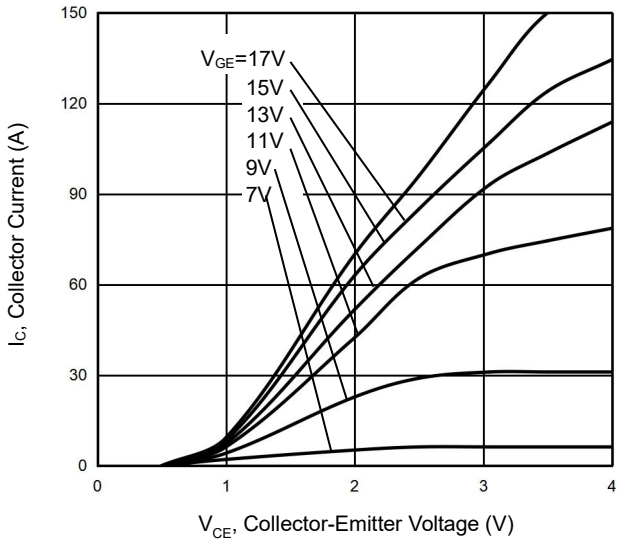


Figure 2 Transfer Characteristics

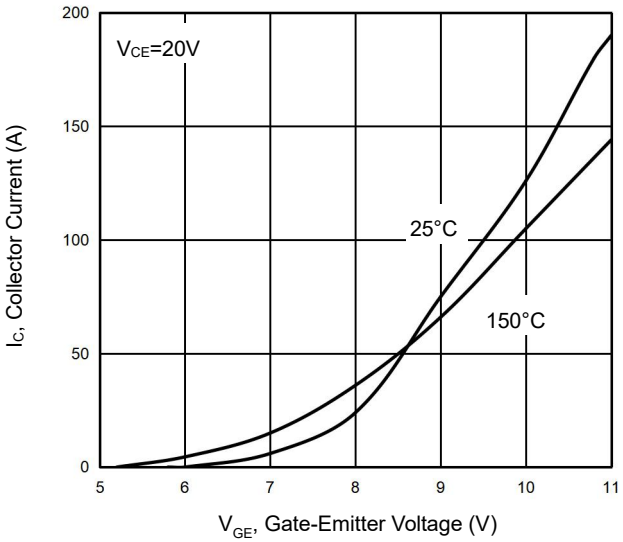


Figure 3 $V_{CE(sat)}$ vs. Case Temperature

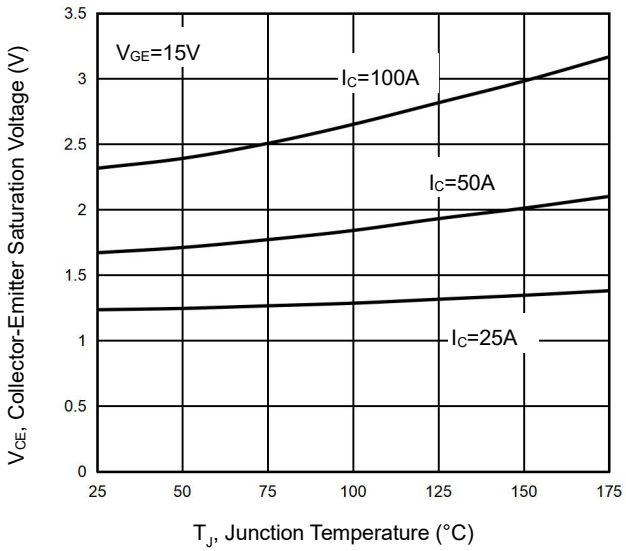


Figure 4 Saturation Voltage vs. V_{GE}

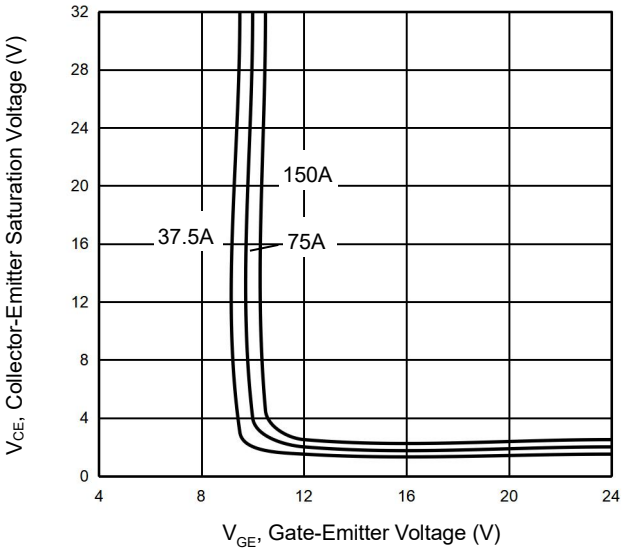


Figure 5 Capacitance Characteristics

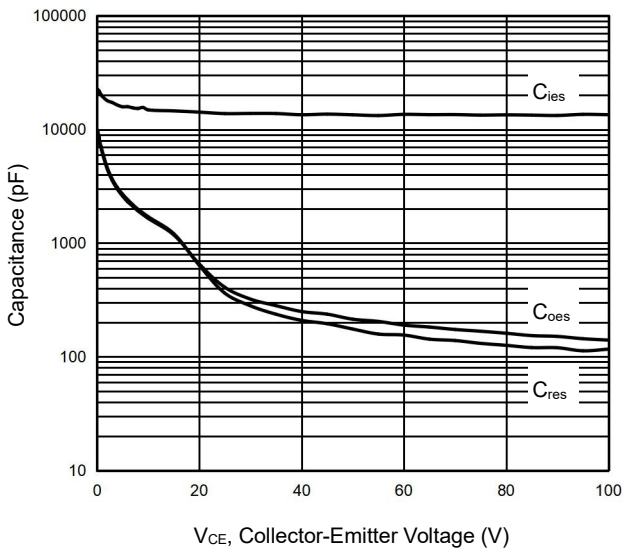
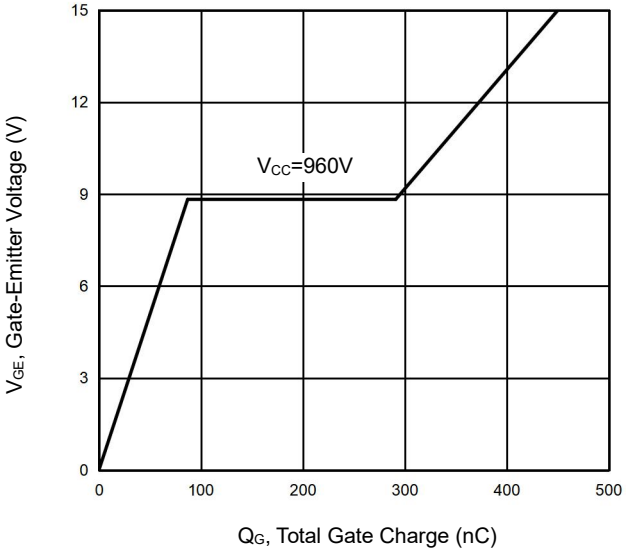
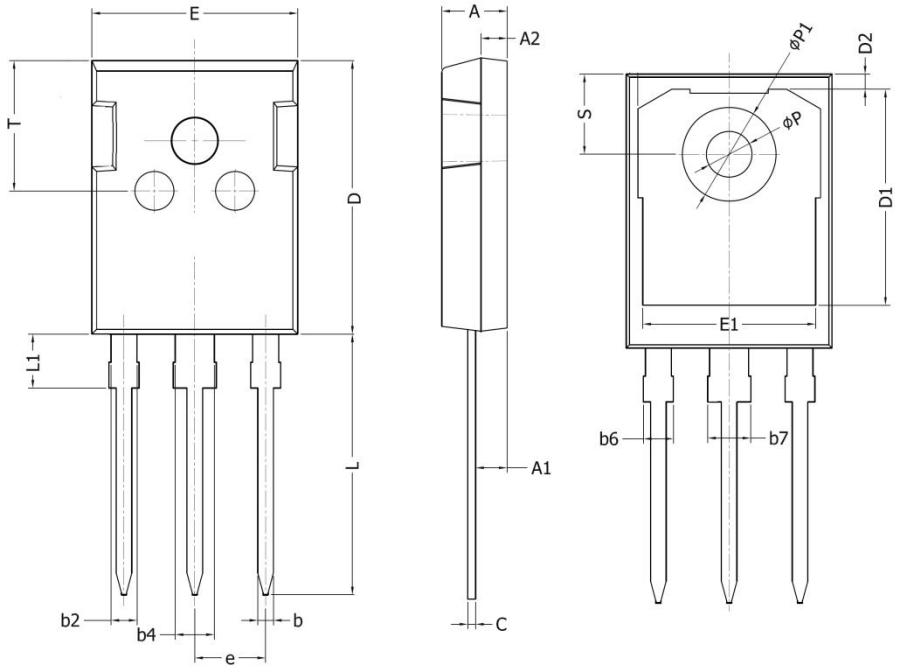


Figure 6 Gate Charge Wave Form



TO-247 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.90	5.10	0.193	0.201
A1	2.31	2.51	0.091	0.099
A2	1.9	2.1	0.075	0.083
b	1.16	1.26	0.046	0.050
b2	1.96	2.06	0.077	0.081
b4	2.96	3.06	0.117	0.120
b6	-	2.25	-	0.089
b7	-	3.25	-	0.128
C	0.59	0.66	0.023	0.026
D	20.90	21.10	0.823	0.831
D1	16.25	16.85	0.640	0.663
D2	1.05	1.35	0.041	0.053
E	15.70	15.90	0.618	0.626
E1	13.10	13.50	0.516	0.531
e	5.436 BSC		0.214 BSC	
L	19.80	20.10	0.780	0.791
L1	-	4.30	-	0.169
P	3.40	3.60	0.134	0.142
P1	7.00	7.40	0.276	0.291
S	6.05	6.25	0.238	0.246
T	9.80	10.20	0.386	0.402

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